Authorized Representative* Title - Representative Phone - Representative* Email - Representative*	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.						
Company name* Company unique ID Unique ID Authority Response Date* 2025-05-14 Contact Name Title - Contact Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product Enviro Compliance Authorized Representative* Product-Env-Stewards Product-Env-Stewards Product Enviro Compliance NA Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Onsen Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM Manufacturing Proccess Information							
nsemi Ontact Name Title - Contact Product Enviro Compliance Unthorized Representative* Title - Representative Title - Representative Title - Representative Product Enviro Compliance NA Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM Anufacturing Proccess Information							
Contact Name Title - Contact Product Enviro Compliance Itile - Representative* Title - Representative Product Enviro Compliance Itile - Representative Product Enviro Compliance NA Product-Env-Stewards@onsen Product-Env-Stewards Product Enviro Compliance NA Product-Env-Stewards@onsen Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM Annufacturing Proccess Information	Response Date*						
Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product Enviro Compliance Product-Env-Stewards Product-Env-Steward	2025-05-14						
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM Authorized Representative* Product-Env-Stewards@onsen Weight* UOM Authorized Representative* Product-Env-Stewards@onsen Weight* UOM Authorized Representative* NA Product-Env-Stewards@onsen Weight* UOM Authorized Representative* Product-Env-Stewards@onsen Weight* UOM Authorized Representative* NA CNJ 329.241 mg	Email - Contact*						
Product-Env-Stewards Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM FDD390N15ALZ FET 150V 42 mOhm DPAK Manufacturing Proccess Information	Product-Env-Stewards@onsemi.com						
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM FDD390N15ALZ FET 150V 42 mOhm DPAK 2025-05-14 CNJ 329.241 mg Manufacturing Proccess Information	Email - Representative*						
FDD390N15ALZ FET 150V 42 mOhm DPAK 2025-05-14 CNJ 329.241 mg Anufacturing Proccess Information	Product-Env-Stewards@onsemi.com						
Manufacturing Proccess Information	Unit Type						
	Each						
Terminal Hading / Orld Afray Material Terminal Base Anoy 3-51D-020 MSL Rating Teak Hocess Body Temperature Max Time at Feat Temperature Indinder of Renow	Sycles						
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	ycies						
omments vel 1 - maximum time at peak temperature during soldering is 10-30 seconds							
vei 1 - maximum time at peak temperature during soldering is 10-30 seconds or more information regarding material composition please refer to page 3							

RoHS Material Composition Declaration			Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.									
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature Ra	astislav Drska	-En							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.16	mg	Supplier	Silicon (Si)	7440-21-3		5.16	mg
Die Attach Solder	5.026		Supplier	Silver (Ag)	7440-22-4		0.1257	mg
			A	Lead (Pb)	7439-92-1	7a	4.6491	mg
			Supplier	Tin (Sn)	7440-31-5		0.2513	mg
Lead Frame	167.854		Supplier	Tin (Sn)	7440-31-5		0.168	mg
			В	Nickel (Ni)	7440-02-0		0.168	mg
			Supplier	Copper (Cu)	7440-50-8		167.518	mg
Mold Compound-Black	149.268			Epoxy resin	proprietary data		8.9561	mg
			Supplier	Phenolic Resin	Proprietary Data		8.9561	mg
			Supplier	Carbon Black (C)	1333-86-4		0.7463	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		126.8778	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3.7317	mg
Plating	1.092	mg	Supplier	Tin (Sn)	7440-31-5		1.092	mg
Wire Bond - Al	0.841	mg	Supplier	Aluminum (Al)	7429-90-5		0.841	mg